

SILICON EPITAXIAL PLANAR OVERLAY TRANSISTORS

The **2N3553** is an n-p-n overlay transistor in a TO-39 metal envelope with the collector connected to the case. The **2N3375** and the **2N3632** are n-p-n overlay transistors in TO-60 metal envelopes with the electrodes insulated from the studs.

The **2N3553** and the **2N3375** are intended for v.h.f./u.h.f. and the **2N3632** for v.h.f. transmitting applications.

QUICK REFERENCE DATA

		2N3553	2N3375	2N3632	
Collector-emitter voltage $-V_{BE} = 1,5 \text{ V}$	V_{CEX} max.	65	65	65	V
Collector-emitter voltage (open base)	V_{CEO} max.	40	40	40	V
Collector current (peak value)	I_{CM} max.	1,0	1,5	3,0	A
Total power dissipation up to $T_{mb} = 25 \text{ }^\circ\text{C}$	P_{tot} max.	7	11,6	23	W
Junction temperature	T_j max.	200	200	200	$^\circ\text{C}$
Transition frequency $I_C = 125 \text{ mA}; V_{CE} = 28 \text{ V}$ $I_C = 250 \text{ mA}; V_{CE} = 28 \text{ V}$	f_T typ.	500	500	—	MHz
	f_T typ.	—	—	400	MHz

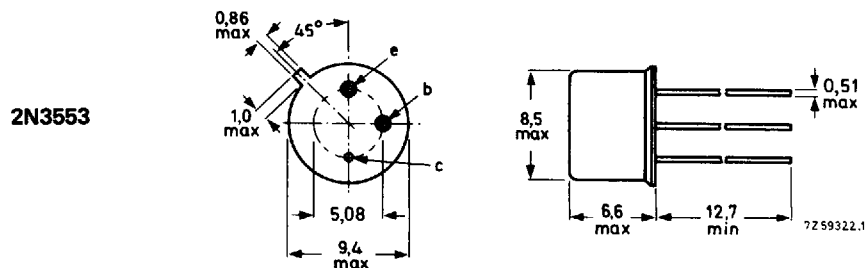
R.F. performance at $V_{CE} = 28 \text{ V}$

type number	f (MHz)	P_o (W)	P_i (W)	η (%)
2N3553	175	2,5	< 0,25	> 50
2N3375	100	7,5	< 1	> 65
2N3375	400	> 3	1	> 40
2N3632	175	> 13,5	3,5	> 70

MECHANICAL DATA

Dimensions in mm

Fig.1a TO-39/1; collector connected to case.



Maximum lead diameter is guaranteed only for 12,7 mm.

Accessories: 56245 (distance disc).

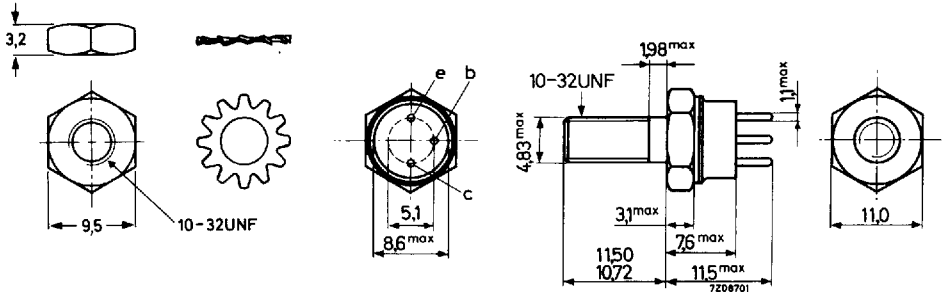
2N3375
2N3553
2N3632

MECHANICAL DATA (continued)

Dimensions in mm

Fig. 1b TO-60 (2N3375 and 2N3632).

The top pins should not be bent.



Torque on nut: min. 0,8 Nm (8 kg cm)
max. 1,7 Nm (17 kg cm)

Diameter of clearance hole in heatsink: 4,8 mm to 5,2 mm.

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic.
The device is entirely safe provided that the BeO disc is not damaged.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-base voltage (open emitter)	V_{CBO}	max.	65	V	
Collector-emitter voltage	V_{CEX}	max.	65	V	
$I_C \leq 200$ mA; $-V_{BE} = 1,5$ V (open base); $I_C \leq 200$ mA	V_{CEO}	max.	40	V	
Emitter-base voltage (open collector)	V_{EBO}	max.	4	V	
Collector current			2N3553	2N3375	2N3632
d.c.	I_C	max.	0,35	0,5	1 A
peak value	I_{CM}	max.	1,0	1,5	3 A
Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max.	7	11,6	23 W
Storage temperature	T_{stg}		-65 to +200		°C
Junction temperature	T_j	max.	200		°C

THERMAL RESISTANCE

	2N3553	2N3375	2N3632
From junction to mounting base	$R_{th\ j-mb} = 25$	15	7.5 K/W
From mounting base to heatsink	$R_{th\ mb-h} =$	0.6	0.6 K/W

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current	2N3553	2N3375	2N3632
$I_B = 0; V_{CE} = 30\text{ V}$	$I_{CEO} < 100$	100	250 μA
Breakdown voltages			
$I_E = 0; I_C = 250\text{ }\mu\text{A}$	$V_{(BR)CBO} > 65$	65	65 V
I_C up to 200 mA	$V_{(BR)CEX} > 65$	65	65 V
$-V_{BE} = 1.5\text{ V}; R_B = 33\text{ }\Omega$ ¹⁾	$V_{(BR)CEO} > 40$	40	40 V
$I_B = 0$ ¹⁾	$V_{(BR)EBO} > 4$	4	4 V
$I_C = 0; I_E = 250\text{ }\mu\text{A}$			
Base-emitter voltage			
$I_C = 250\text{ mA}; V_{CE} = 5\text{ V}$	$V_{BE} < 1.5$		V
$I_C = 500\text{ mA}; V_{CE} = 5\text{ V}$	$V_{BE} <$	1.5	V
$I_C = 1000\text{ mA}; V_{CE} = 5\text{ V}$	$V_{BE} <$		1.5 V
Saturation voltage			
$I_C = 250\text{ mA}; I_B = 50\text{ mA}$	$V_{CEsat} < 1.0$		V
$I_C = 500\text{ mA}; I_B = 100\text{ mA}$	$V_{CEsat} <$	1.0	V
$I_C = 1000\text{ mA}; I_B = 200\text{ mA}$	$V_{CEsat} <$		1.0 V

¹⁾ Pulsed through an inductor of 25 mH; $\delta = 0.5$; $f = 50\text{ Hz}$

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

D.C. current gain

$I_C = 125\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} >$
 $h_{FE} <$

2N3553	2N3375	2N3632
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15	15	
200	200	

$I_C = 250\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} >$
 $h_{FE} <$

10	10	10
100	100	150

$I_C = 1000\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} >$
 $h_{FE} <$

5
110

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 28\text{ V}$

$C_c <$

10	10	20 pF
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Collector-case capacitance

$<$

6	6 pF
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Transition frequency

$I_C = 125\text{ mA}; V_{CE} = 28\text{ V}$

f_T typ. 500

500

MHz

$I_C = 250\text{ mA}; V_{CE} = 28\text{ V}$

f_T typ.

400 MHz

Real part of input impedance at $f = 200\text{ MHz}$

$I_C = 125\text{ mA}; V_{CE} = 28\text{ V}$

$\text{Re}(h_{ie}) <$

20

Ω

$I_C = 250\text{ mA}; V_{CE} = 28\text{ V}$

$\text{Re}(h_{ie}) <$

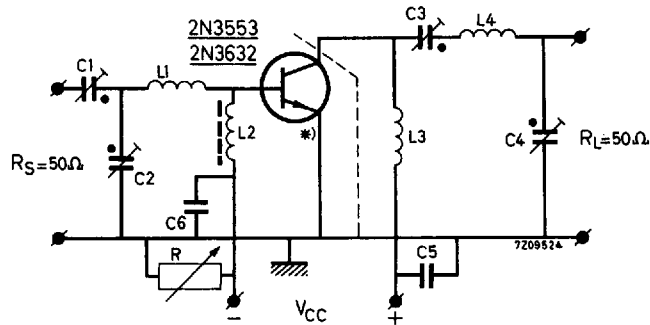
20 Ω

R.F. performance at $V_{CE} = 28\text{ V}$

	f (MHz)	P_o (W)	P_i (W)	I_C (mA)	η %	Test circuit
2N3553	175	2.5	< 0.25	< 180	> 50	I
2N3375	100	7.5	< 1	< 410	> 65	II
2N3375	400	> 3	1	270	> 40	III
2N3632	175	> 13.5	3.5	690	> 70	I

NOTE

The transistors can withstand an output V.S.W.R. of 3:1 varied through all phases under conditions mentioned in the table above.

CHARACTERISTICS (continued)Test circuit 1 (with the 2N3553 or the 2N3632 at $f = 175$ MHz)

- *.) The length of the external emitter wire of the 2N3553 is 1.6 mm.
The emitter of the 2N3632 should be connected to the case as short as possible.

Components

C1 = C2 = C3 = C4 = 4 to 29 pF air trimmer

C5 = 10 nF polyester

C6 = 100 pF ceramic

L1 = 1 turn Cu wire (1.0 mm); int. diam. 10 mm; leads 2 x 10 mm

L2 = Ferroxcube choke coil. Z (at $f = 175$ MHz) = $550 \Omega \pm 20\%$
(code number 4312 020 36640)

L3 = 15 turns closely wound enamelled Cu wire (0.7 mm); int. diam. 4 mm

L4 = 3 turns closely wound enamelled Cu wire (1.5 mm); int. diam. 12 mm; leads
2 x 20 mm

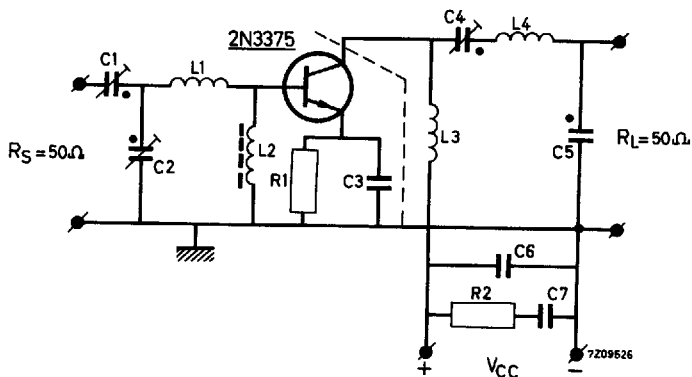
R = 0 for the 2N3553

R = 0 to 2 Ω for the 2N3632

2N3375
2N3553
2N3632

CHARACTERISTICS (continued)

Test circuit II (with the 2N3375 at $f = 100$ MHz)



Components

C1 = C2 = 3.5 to 61.5 pF air trimmer

C3 = 10 nF polyester

C4 = C5 = 4 to 29 pF air trimmer

C6 = 330 pF ceramic

C7 = 10 nF polyester

L1 = 2 turns closely wound enamelled Cu wire (1.5 mm); int. diam. 10 mm; leads 2 x 10 mm

L2 = Ferroxcube choke coil. Z (at $f = 100$ MHz) = $700 \Omega \pm 20\%$
(code number 4312 020 36640)

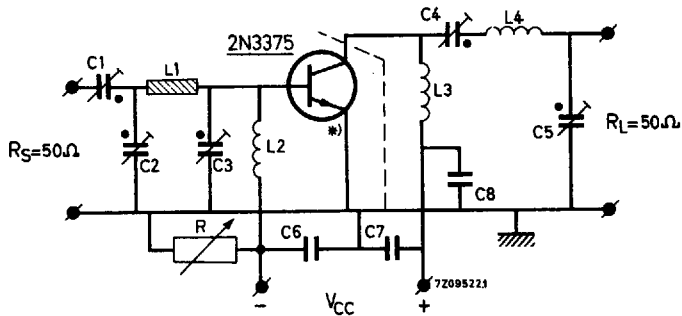
L3 = 23 turns closely wound enamelled Cu wire (0.7 mm); int. diam. 6 mm

L4 = 5 turns closely wound enamelled Cu wire (1.5 mm); int. diam. 12 mm; leads 2 x 10 mm

R1 = 1.35 Ω carbon

R2 = 10 Ω carbon

CHARACTERISTICS (continued)

Test circuit III (with the 2N3375 at $f = 400$ MHz)

*) The emitter should be connected to the case as short as possible.

Components

C1 = C2 = 0.7 to 6.7 pF ceramic trimmer

C3 = 0.5 to 3.5 pF ceramic trimmer

C4 = C5 = 3 to 19 pF air trimmer

C6 = C7 = 15 pF ceramic

C8 = 4700 pF ceramic

L1 = 20 mm straight Cu wire; diam. 1.5 mm; spaced 8 mm from chassis

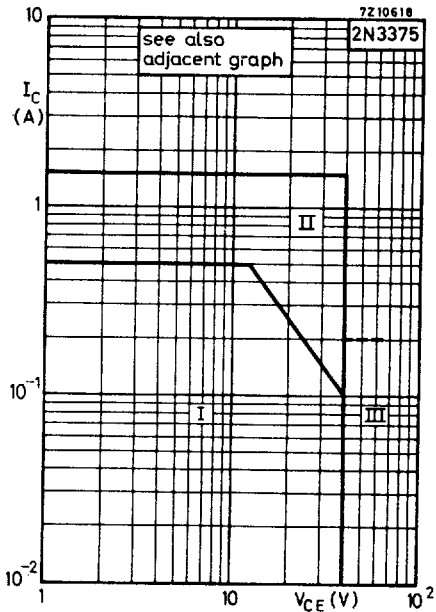
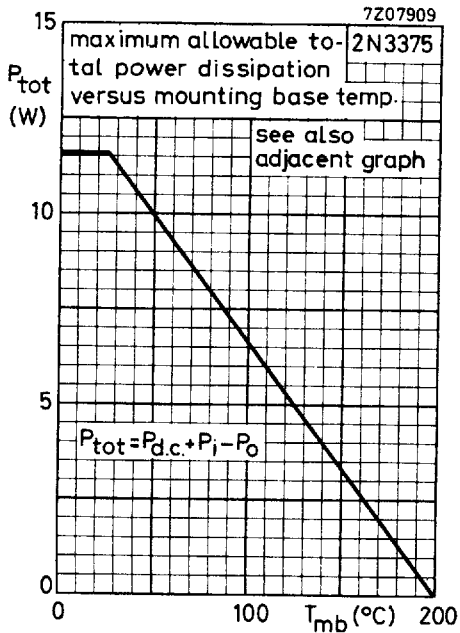
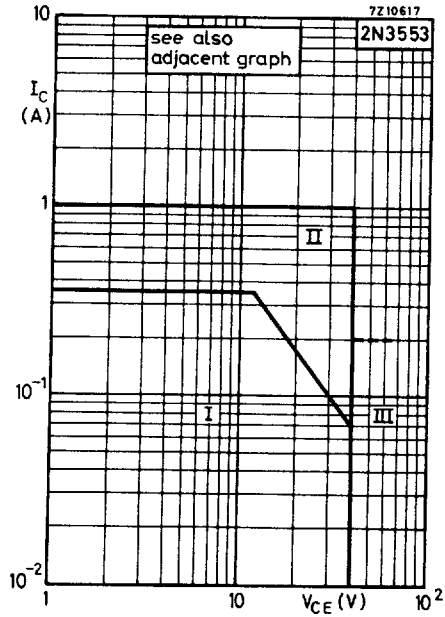
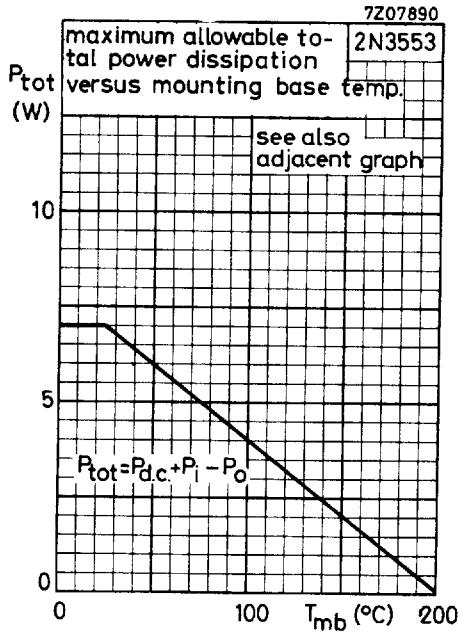
L2 = 17 turns closely wound enamelled Cu wire (0.5 mm); int. diam. 3 mm

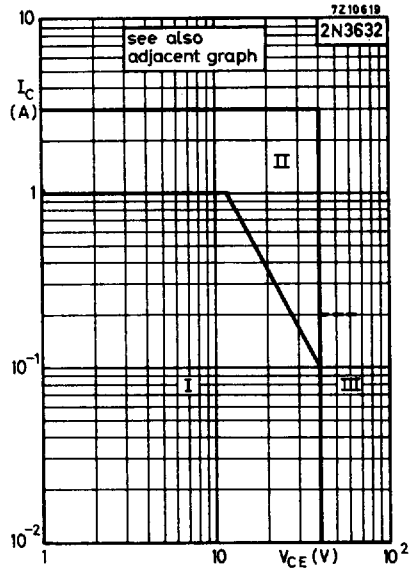
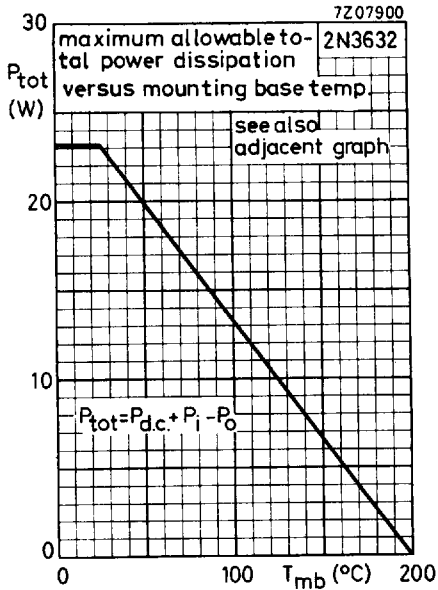
L3 = 7 turns closely wound enamelled Cu wire (0.5 mm); int. diam. 3 mm

L4 = 1 turn Cu wire (1.5 mm); int. diam. 10 mm; leads 2 x 5 mm

R = 0 to 5 Ω

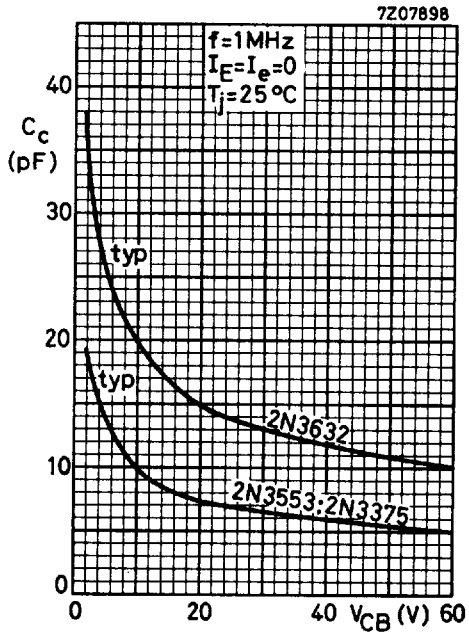
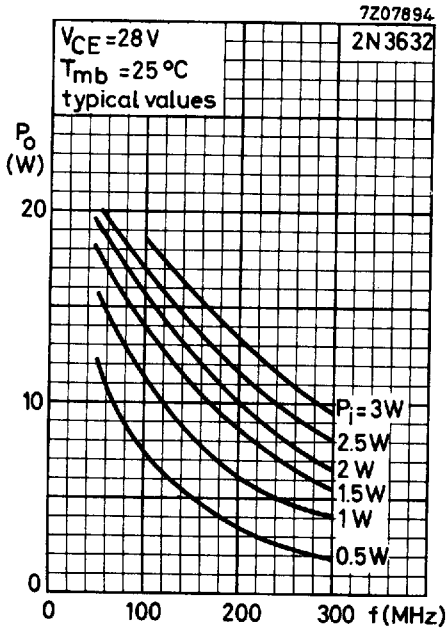
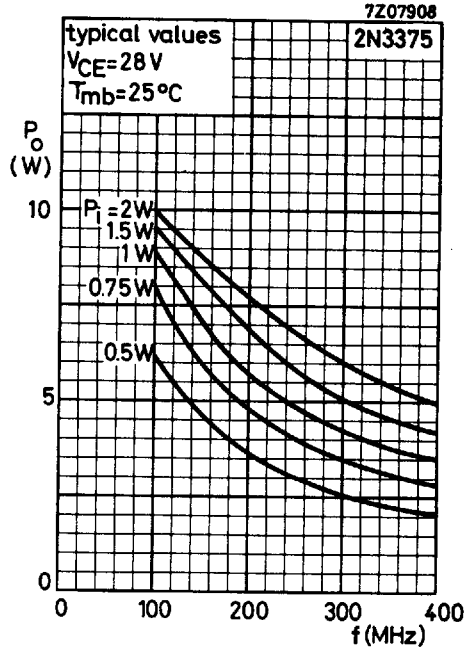
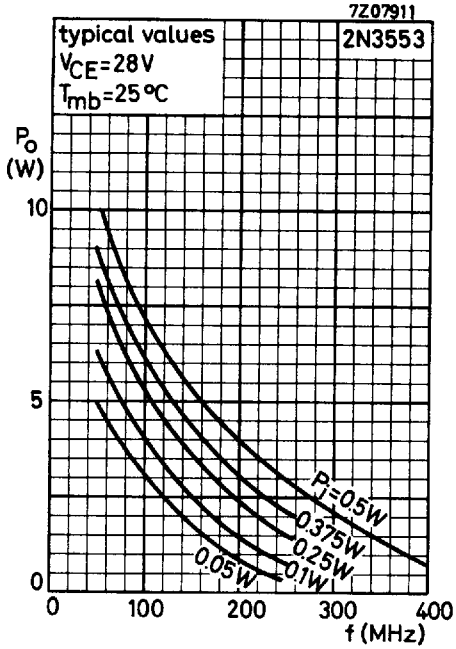
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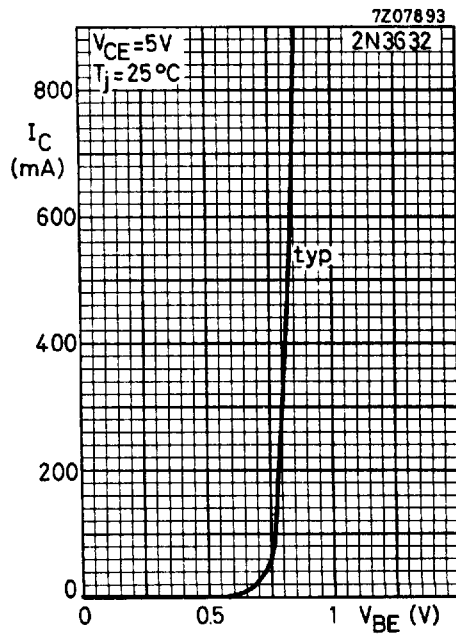
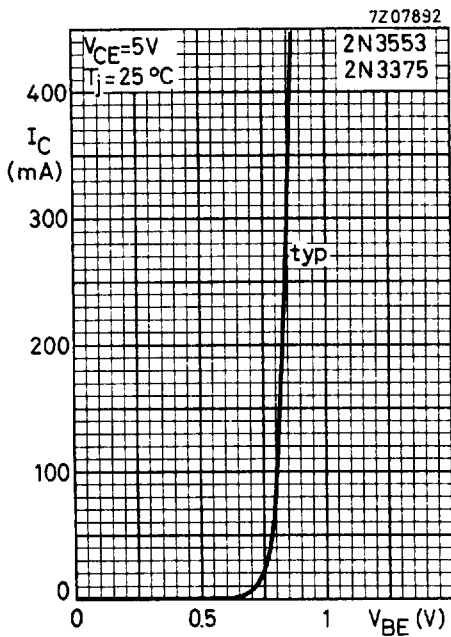
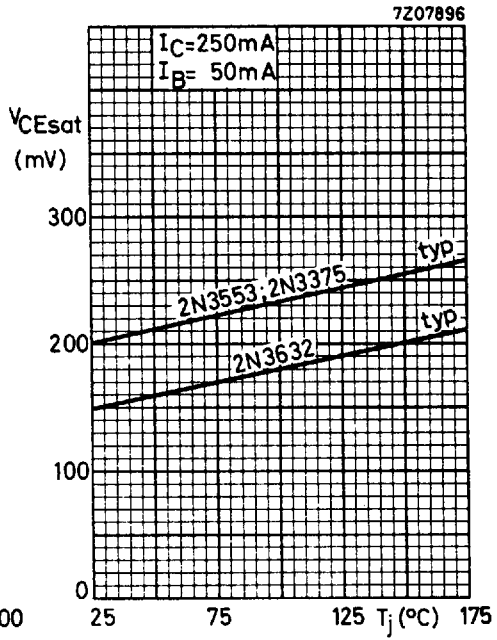
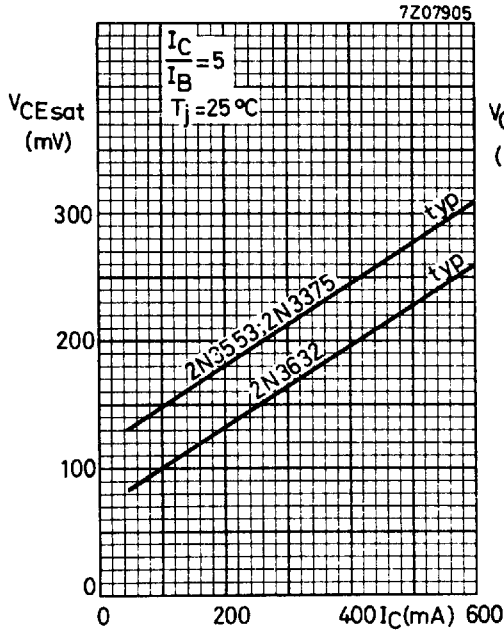




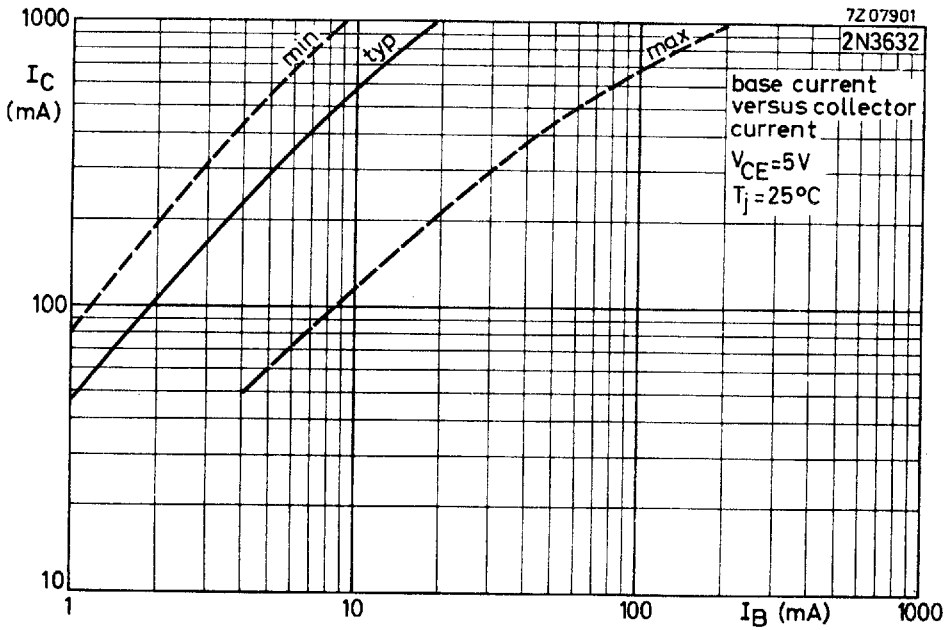
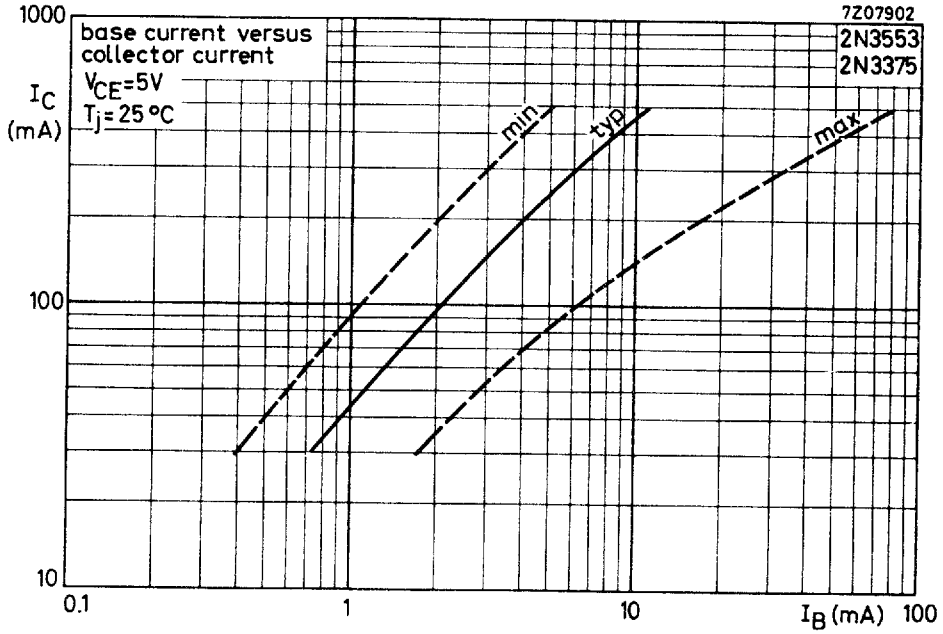
- I Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.
- II Additional region of operation at $f \geq 1$ MHz.
Care must be taken to reduce the d.c. adjustment to region I before removing the a.c. signal. This may be achieved by an appropriate bias in class A, B or C.
- III Operating during switching off in this region is allowed, provided the transistor is cut-off with $-V_{BB} \leq 1.5$ V and $R_{BE} \geq 33 \Omega$, $I_C \leq 200$ mA and the transient energy does not exceed 0.5 mWs.

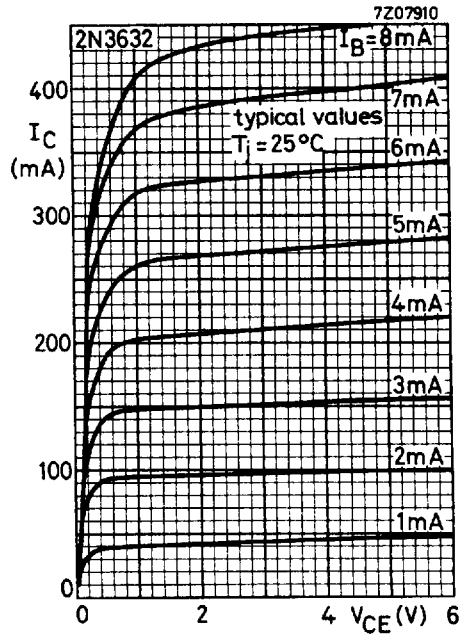
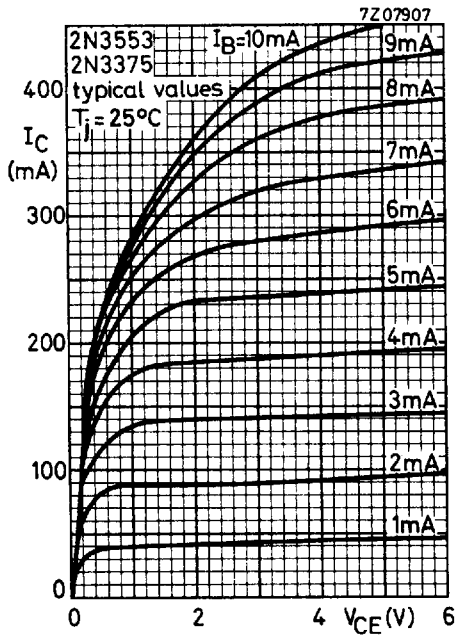
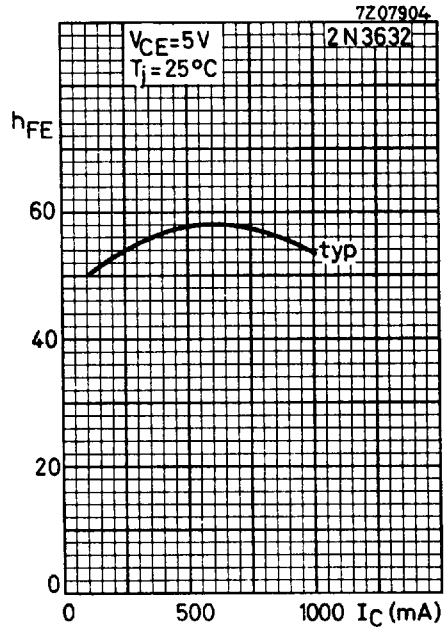
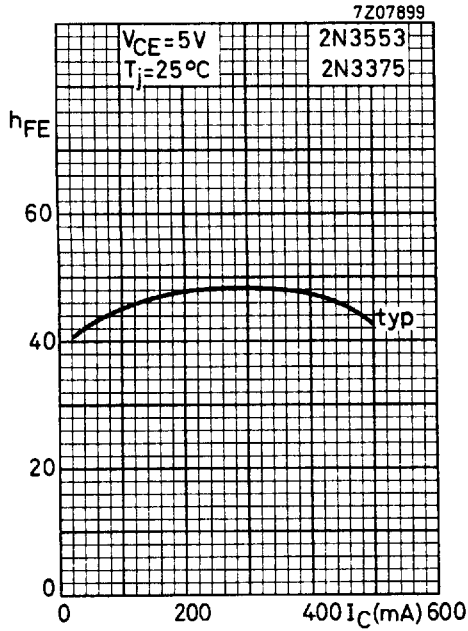
2N3375
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